

Vishay Siliconix

N-Channel 30 V (D-S) MOSFET

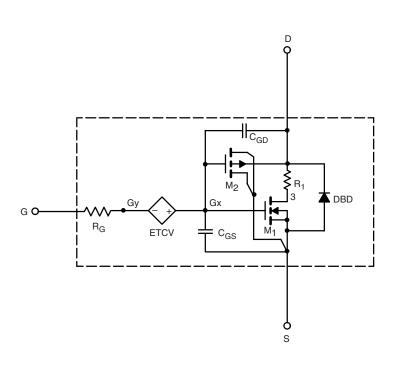
DESCRIPTION

The attached SPICE model describes the typical electrical characteristics of the n-channel vertical DMOS. The subcircuit model is extracted and optimized over the - 55 °C to + 125 °C temperature ranges under the pulsed 0 V to 10 V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage. A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched C_{gd} model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.

SUBCIRCUIT MODEL SCHEMATIC

CHARACTERISTICS

- N-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS
- · Apply for both Linear and Switching Application
- Accurate over the 55 °C to + 125 °C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics



Note

This document is intended as a SPICE modeling guideline and does not constitute a commercial product datasheet. Designers should refer to the appropriate datasheet of the same number for guaranteed specification limits.

SPICE Device Model SUP90N03-03

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SPECIFICATIONS $T_J = 25 \text{ °C}$, unless otherwise noted					
PARAMETER	SYMBOL	TEST CONDITIONS	SIMULATED DATA	MEASURED DATA	UNIT
Static					
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2	-	V
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 28.8 \text{ A}$	0.0025	0.0024	Ω
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 27 \text{ A}$	0.0028	0.0027	
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 28.8 \text{ A}$	161	160	S
Diode Forward Voltage ^a	V _{SD}	I _S = 22 A	0.78	0.80	V
Dynamic ^b					
Input Capacitance	C _{iss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	12 000	12 065	pF
Output Capacitance	C _{oss}		1820	1725	
Reverse Transfer Capacitance	C _{rss}		838	970	
Total Gate Charge	0	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 28.8 \text{ A}$	185	171	nC
	Qg	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 28.8 \text{ A}$	94	81.5	
Gate-Source Charge	Q _{gs}		34	34	
Gate-Drain Charge	Q _{gd}		29	29	

Notes

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

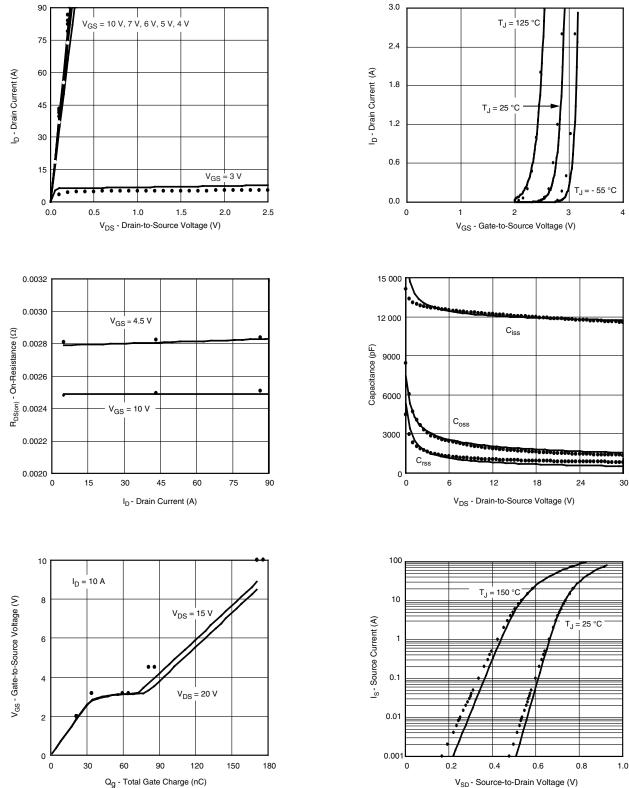


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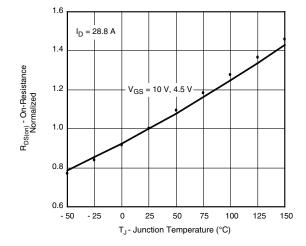
Note

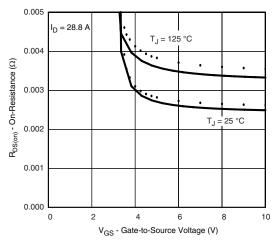
Dots and squares represent measured data.

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COMPARISON OF MODEL WITH MEASURED DATA T_J = 25 °C, unless otherwise noted







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